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# 1 Electrical data

## 1.1 Maximum ratings

**Table 2. Absolute maximum ratings** ( $T_{CASE} = 25^{\circ}C$ )

Symbol	Parameter	Value	Unit
$V_{(BR)DSS}$	Drain-source voltage	25	V
$V_{GS}$	Gate-source voltage	-0.5 to +15	V
$I_D$	Drain current	7	A
$P_{DISS}$	Power dissipation (@ $T_C = 70^{\circ}C$ )	79	W
$T_J$	Max. operating junction temperature	165	$^{\circ}C$
$T_{STG}$	Storage temperature	-65 to +150	$^{\circ}C$

## 1.2 Thermal data

**Table 3. Thermal data**

Symbol	Parameter	Value	Unit
$R_{thJC}$	Junction - case thermal resistance	1.2	$^{\circ}C/W$

## 2 Electrical characteristics

$$T_{\text{CASE}} = +25\text{ }^{\circ}\text{C}$$

### 2.1 Static

**Table 4. Static**

Symbol	Test conditions		Min	Typ	Max	Unit
$I_{\text{DSS}}$	$V_{\text{GS}} = 0\text{ V}$	$V_{\text{DS}} = 25\text{ V}$			1	$\mu\text{A}$
$I_{\text{GSS}}$	$V_{\text{GS}} = 20\text{ V}$	$V_{\text{DS}} = 0\text{ V}$			1	$\mu\text{A}$
$V_{\text{GS(Q)}}$	$V_{\text{DS}} = 10\text{ V}$	$I_{\text{D}} = 250\text{ mA}$	3.2		4.8	V
$V_{\text{DS(ON)}}$	$V_{\text{GS}} = 10\text{ V}$	$I_{\text{D}} = 1\text{ A}$		0.27	0.31	V
$C_{\text{ISS}}$	$V_{\text{GS}} = 0\text{ V}$	$V_{\text{DS}} = 7\text{ V}$		56		pF
$C_{\text{OSS}}$	$V_{\text{GS}} = 0\text{ V}$	$V_{\text{DS}} = 7\text{ V}$		47		pF
$C_{\text{RSS}}$	$V_{\text{GS}} = 0\text{ V}$	$V_{\text{DS}} = 7\text{ V}$		2.2		pF

### 2.2 Dynamic

**Table 5. Dynamic**

Symbol	Test conditions		Min	Typ	Max	Unit
P3dB	$V_{\text{DD}} = 7.5\text{ V}$ , $I_{\text{DQ}} = 250\text{ mA}$	$f = 870\text{ MHz}$	8	9.5		W
$G_{\text{P}}$	$V_{\text{DD}} = 7.5\text{ V}$ , $I_{\text{DQ}} = 250\text{ mA}$ , $P_{\text{OUT}} = 2\text{ W}$ , $f = 870\text{ MHz}$		13	16.2		dB
$h_{\text{D}}$	$V_{\text{DD}} = 7.5\text{ V}$ , $I_{\text{DQ}} = 250\text{ mA}$ , $P_{\text{OUT}} = \text{P3dB}$ , $f = 870\text{ MHz}$		55	65		%
Load mismatch	$V_{\text{DD}} = 9.5\text{ V}$ , $I_{\text{DQ}} = 250\text{ mA}$ , $P_{\text{OUT}} = 15\text{ W}$ , $f = 870\text{ MHz}$ All phase angles		20:1			VSWR

### 2.3 ESD protection characteristics

**Table 6. ESD protection characteristics**

Test conditions	Class
Human body model	2
Machine model	M3

### 2.4 Moisture sensitivity level

**Table 7. Moisture sensitivity level**

Test methodology	Rating
J-STD-020B	MSL 3

3 Impedance

Figure 2. Current conventions

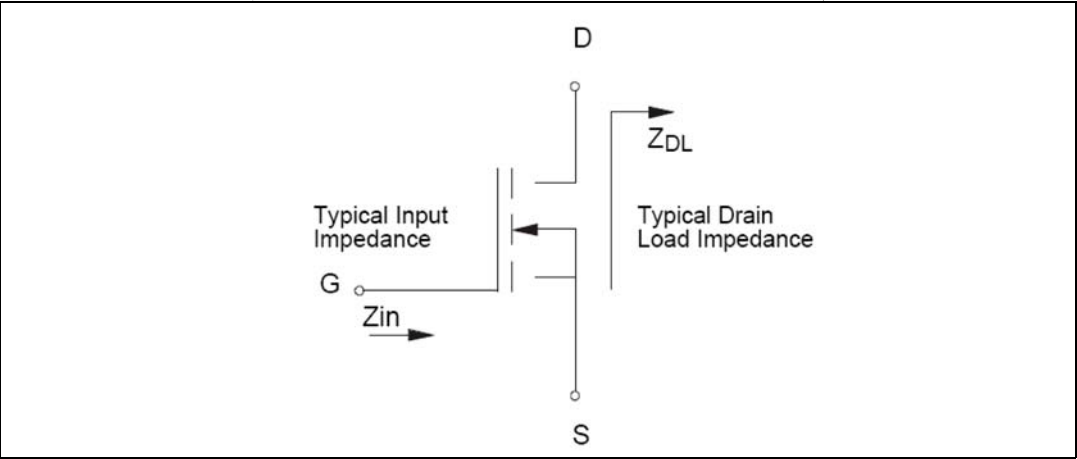


Table 8. Impedance data

Freq. (MHz)	$Z_{IN} (\Omega)$	$Z_{DL}(\Omega)$
870 MHz	$0.38 + j\ 0.94$	$1.36 - j\ 0.48$

# 4 Typical performance

Figure 3. Capacitances vs drain voltage

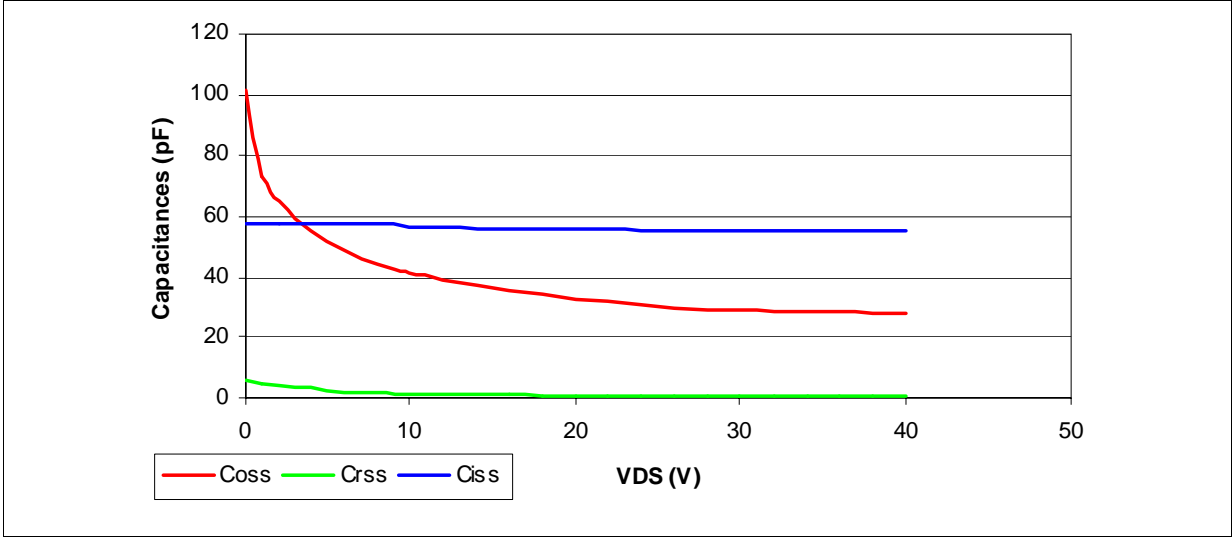


Figure 4. DC output characteristics

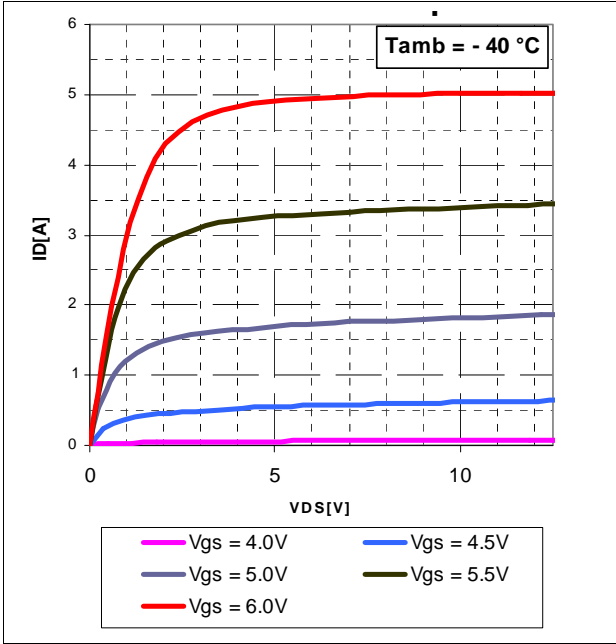


Figure 5. DC output characteristics

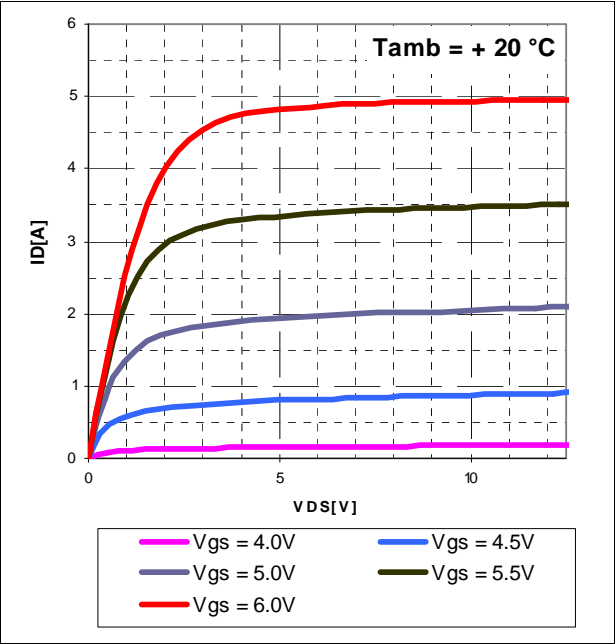


Figure 6. DC output characteristics

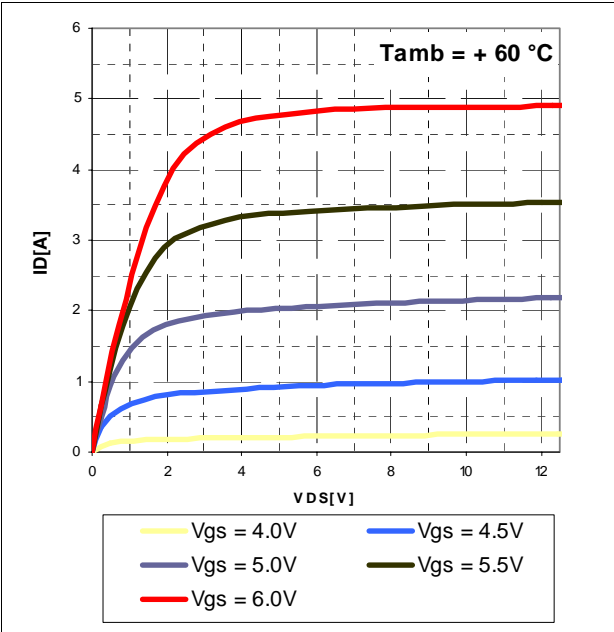


Figure 7. Gain vs output power and bias current

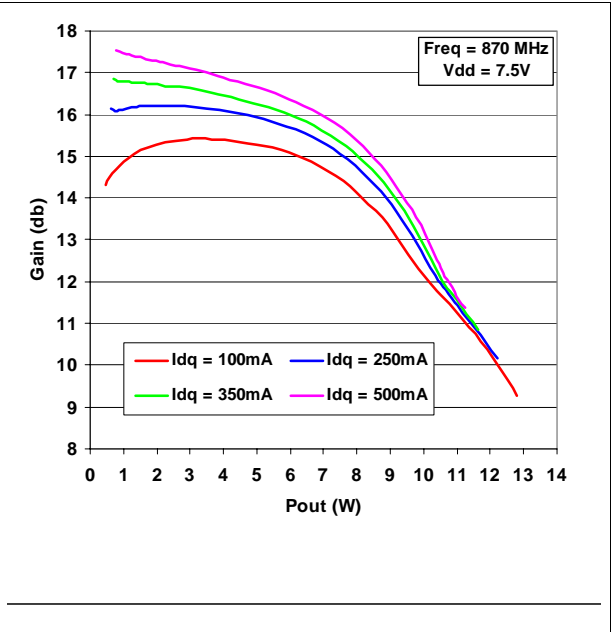


Figure 8. Gain and efficiency vs  $P_{OUT}$

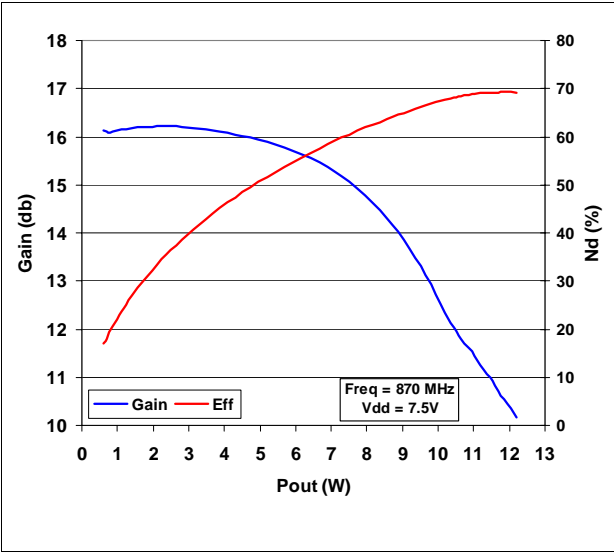


Figure 9.  $P_{out}$  and  $I_d$  vs  $V_{GS}$

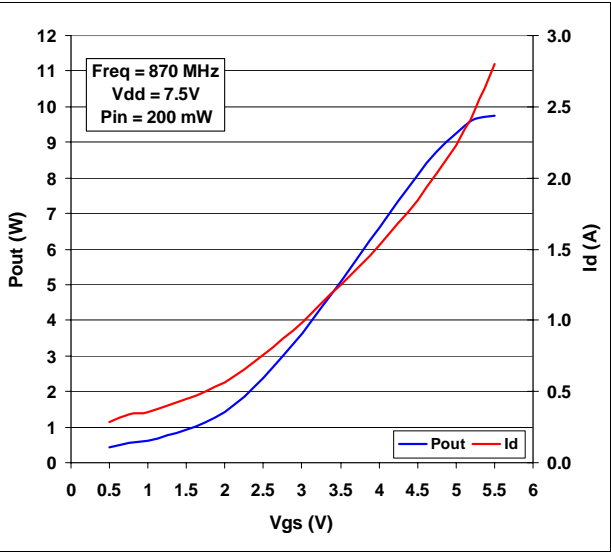


Figure 10. Pout and Id vs Vgs

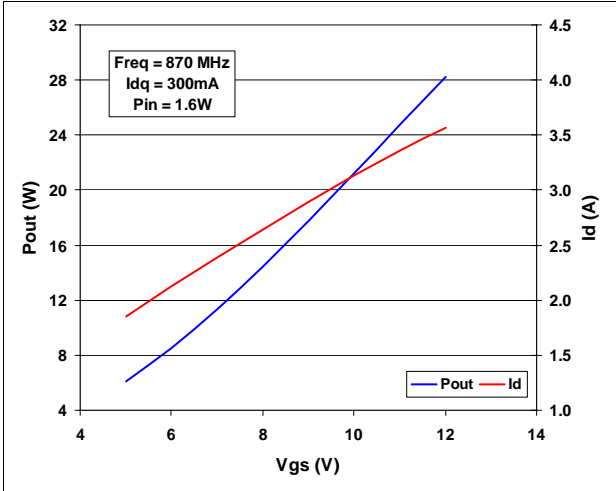


Figure 11. Pout and Id vs VDD

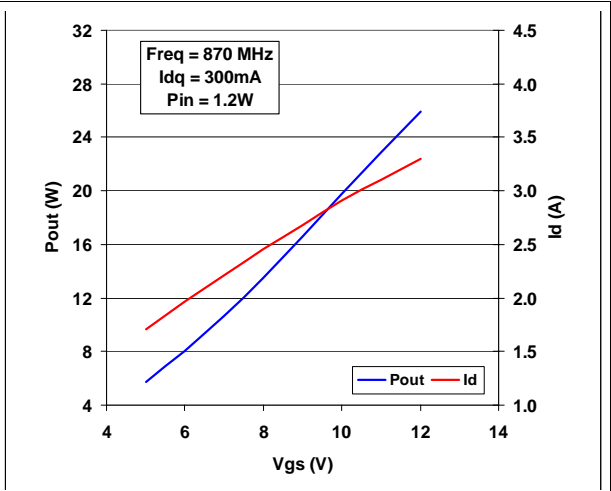


Figure 12. Pout and Id vs VDD

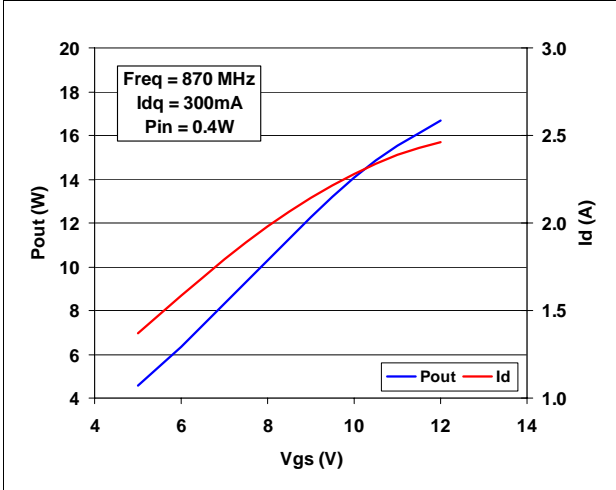


Figure 13. Pout and Id vs VDD

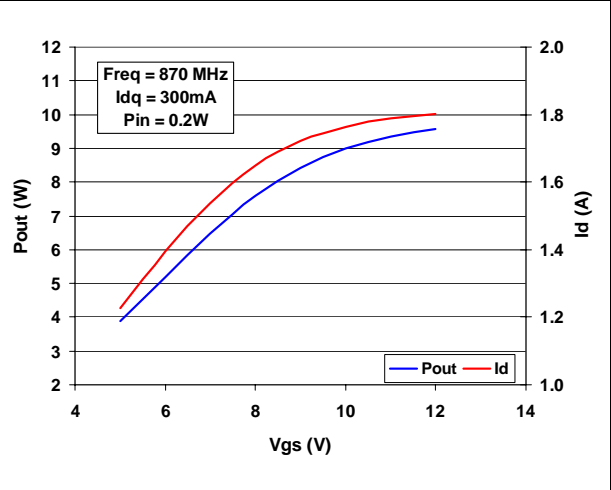
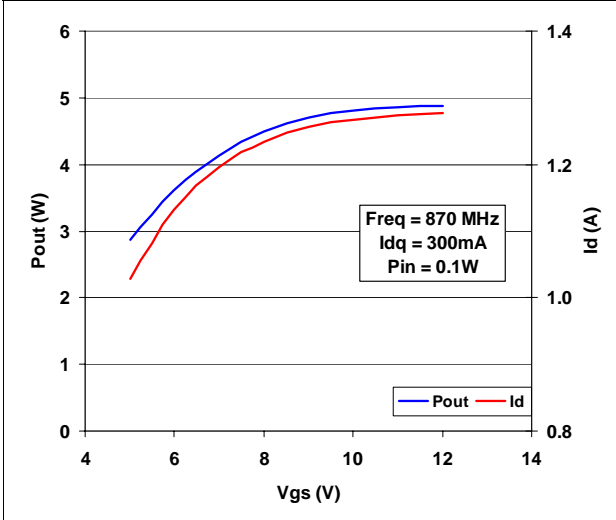


Figure 14. Pout and Id vs VDD



## 5 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.



**Table 9. PowerSO-10RF Formed lead (gull wing) mechanical data**

Dim.	mm.			Inch		
	Min	Typ	Max	Min	Typ	Max
A1	0	0.05	0.1	0.	0.0019	0.0038
A2	3.4	3.5	3.6	0.134	0.137	0.142
A3	1.2	1.3	1.4	0.046	0.05	0.054
A4	0.15	0.2	0.25	0.005	0.007	0.009
a		0.2			0.007	
b	5.4	5.53	5.65	0.212	0.217	0.221
c	0.23	0.27	0.32	0.008	0.01	0.012
D	9.4	9.5	9.6	0.370	0.374	0.377
D1	7.4	7.5	7.6	0.290	0.295	0.298
E	13.85	14.1	14.35	0.544	0.555	0.565
E1	9.3	9.4	9.5	0.365	0.37	0.375
E2	7.3	7.4	7.5	0.286	0.292	0.294
E3	5.9	6.1	6.3	0.231	0.24	0.247
F		0.5			0.019	
G		1.2			0.047	
L	0.8	1	1.1	0.030	0.039	0.042
R1			0.25			0.01
R2		0.8			0.031	
T	2 deg	5 deg	8 deg	2 deg	5 deg	8 deg
T1		6 deg			6 deg	
T2		10 deg			10 deg	

**Note:** *Resin protrusions not included (max value: 0.15 mm per side)*

[illegible]

Dim.	mm.			Inch		
	Min	Typ	Max	Min	Typ	Max
A1	1.62	1.67	1.72	0.064	0.065	0.068
A2	3.4	3.5	3.6	0.134	0.137	0.142
A3	1.2	1.3	1.4	0.046	0.05	0.054
A4	0.15	0.2	0.25	0.005	0.007	0.009
a		0.2			0.007	
b	5.4	5.53	5.65	0.212	0.217	0.221
c	0.23	0.27	0.32	0.008	0.01	0.012
D	9.4	9.5	9.6	0.370	0.374	0.377
D1	7.4	7.5	7.6	0.290	0.295	0.298
E	15.15	15.4	15.65	0.595	0.606	0.615
E1	9.3	9.4	9.5	0.365	0.37	0.375
E2	7.3	7.4	7.5	0.286	0.292	0.294
E3	5.9	6.1	6.3	0.231	0.24	0.247
F		0.5			0.019	
G		1.2			0.047	
R1			0.25			0.01
R2		0.8			0.031	
T1		6 deg			6 deg	
T2		10 deg			10 deg	

Note:        *Resin protrusions not included (max value: 0.15 mm per side)*

**Figure 16. Package dimensions**

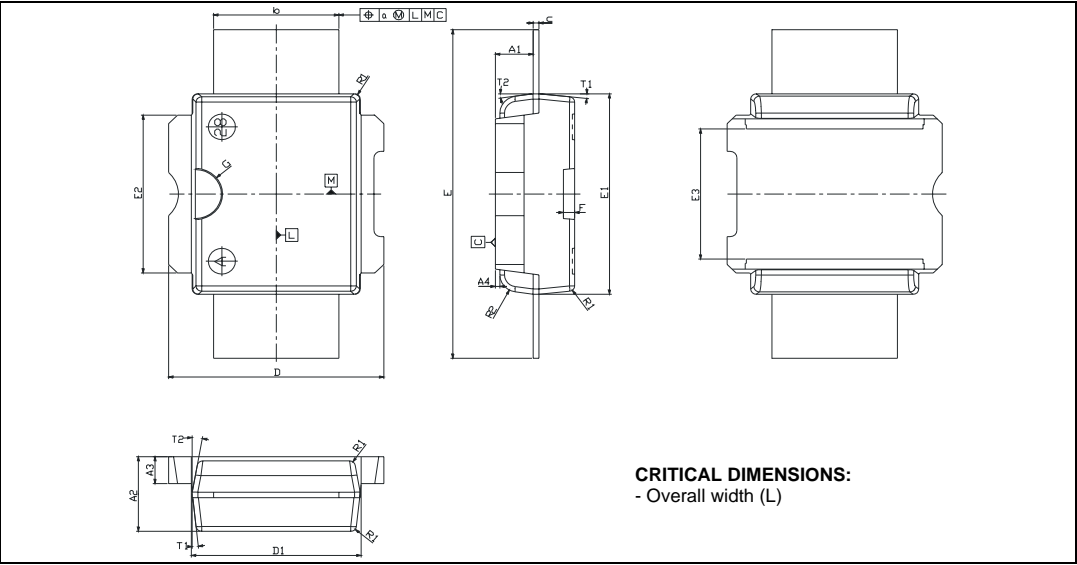


Figure 17. Tube information

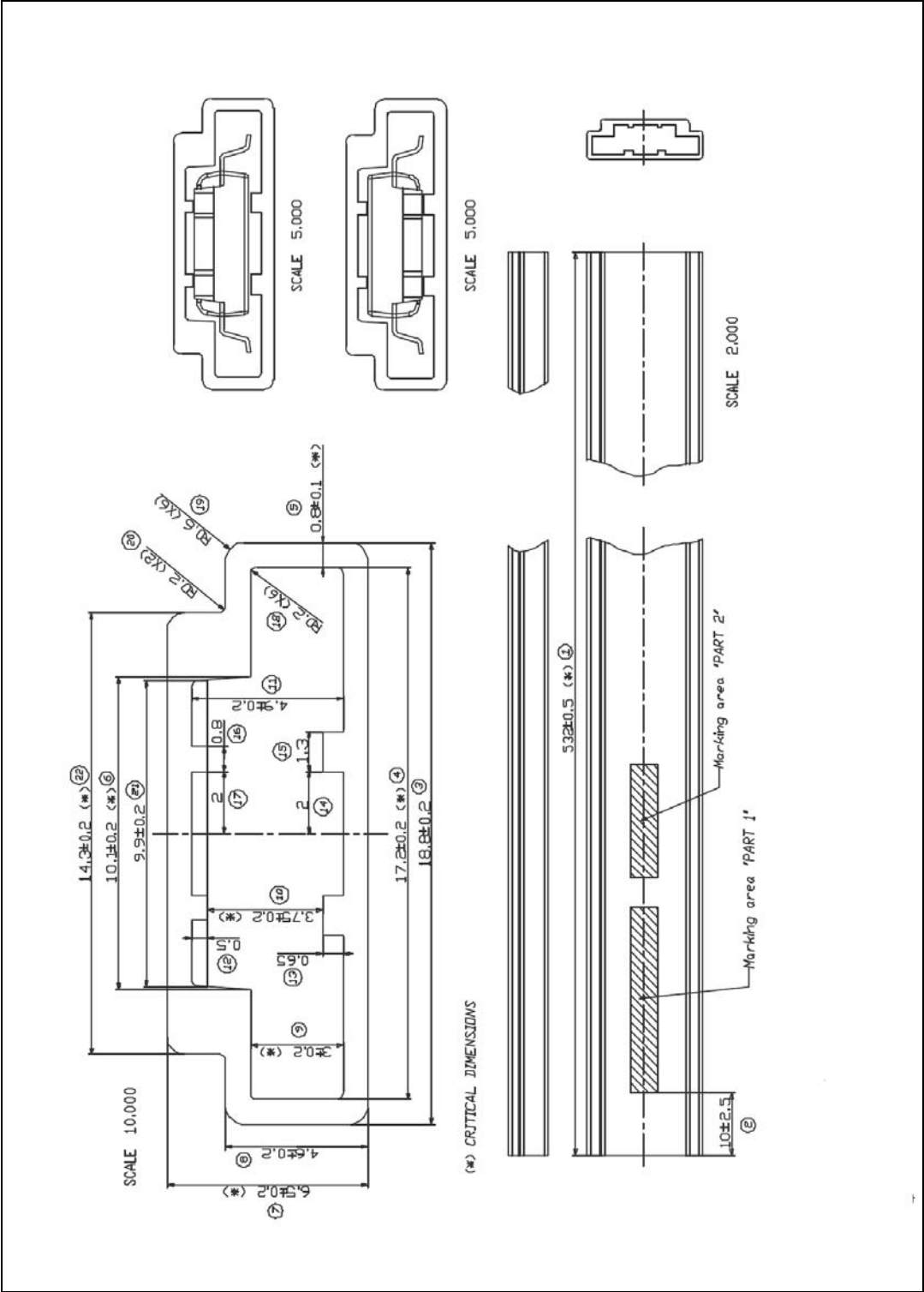
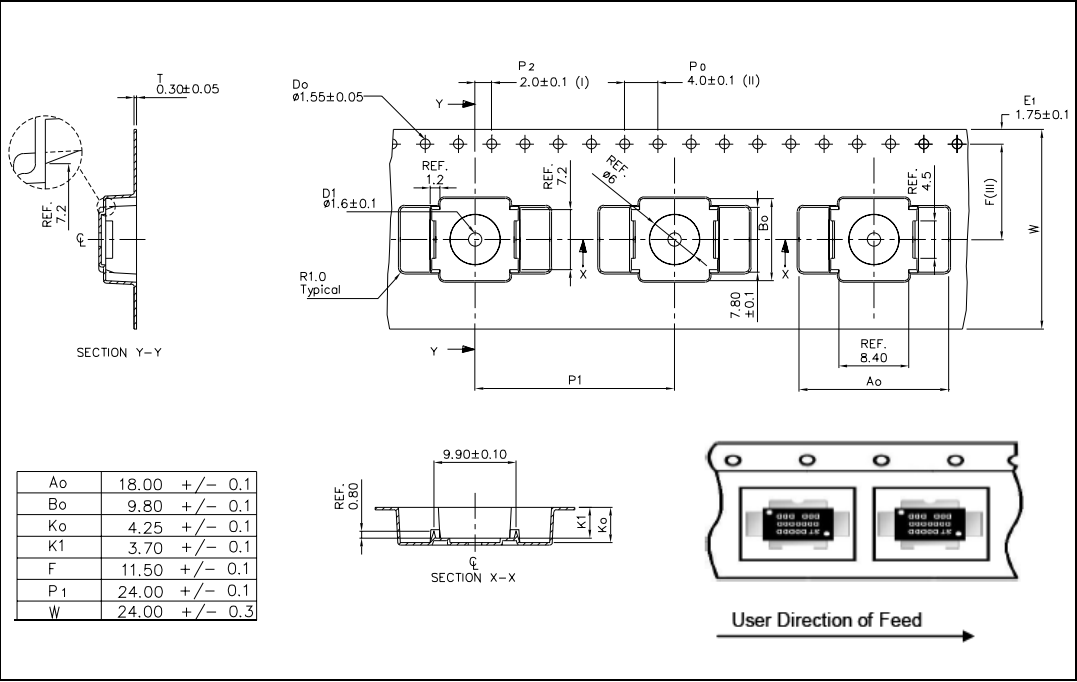


Figure 18. Reel information



## 6 Revision history

**Table 11. Document revision history**

Date	Revision	Changes
05-Dec-2007	1	Initial release.
28-Jun-2011	2	Updated <a href="#">Table 4</a> .

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